

Specification Sheet

Model No.: MTF0397SWI-06

Description: 3.97 inch 480 x 800 Pixel Resolution

MIPI Interface TFT LCD Module

Option Capacitance Touch Panel

Microtech Technology Co. Ltd.

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Document revision history:

Documen	t revision his	tory:		
DOCUMENT REVISION	DATE	DESCRIPTION	PREPARED BY	APPROVED BY
01	2016.06.12	First Release.	QSC	QSC

2. General Description

3.97"(diagonal), 480 x3 RGB x 800 dots, 16.7M colors, Transmissive, TFT LCD module.

Viewing Direction: ALL clock.

Driving IC:OTM8019A

MIPI interface

Logic voltage: 2.8V (typ.).

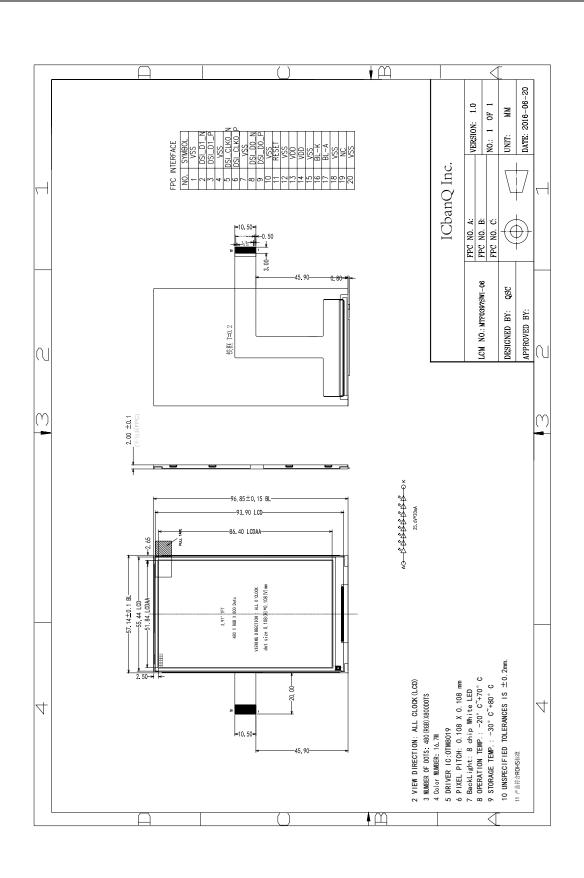
Without touch panel.

3. Mechanical Specifications

The mechanical detail is shown in Fig. 1 and summarized in Table 1 below.

Table 1

Parameter		Specifications	Unit
Outline	dimensions	57.14(W) x 96.85(H) x2.0+_0.05(D)	mm
	active area	51.84(W)*86.4(H)	mm
	Display format	480x3 RGB x 800	dots
	Color configuration	RGB stripes	-
Dot pitch		$0.108(RGB)(W) \times 0.108(H)$	mm
Weight		TBD	grams



4. Interface signals

PinNo.	Symbol	Description			
1	GND	Ground			
2	D1N	MIPI_DSI data lane 1 negative _end input pin			
3	D1P	MIPI_DSI data lane 1 positive end input pin			
4	GND	Ground			
5	CN	MIPI_DSI clock lane negative_ end input pin			
6	СР	MIPI_DSI clock lane positive_ end input pin			
7	GND	Ground			
8	D0N	MIPI_DSI data lane 0 negative _ end input pin			
9	D0P	MIPI_DSI data lane 0 positive_ end input pin			
10	GND	Ground			
11	RESET	Reset signal pin			
12	GND	Ground			
13	IOVCC	I/O supply voltage range1.8V			
14	VCC	Power supply for the system 2.8V			
15	GND	Ground			
16	LEDK	Anode K			
17	LEDA	Anode A			
18	GND	Ground			
19	NC				
20	GND	Ground			

5. Absolute Maximum Ratings

5.1 Electrical Maximum Ratings – for IC Only

<u>Table 3: Electrical Maximum Ratings – for IC</u>

Parameter	Symbol	Min.	Max.	Unit	Note
Power supply voltage (VDD)	VCC	-0.3	+3.6	V	1

Note:

- 1. VCC, GND must be maintained.
- 2. The modules may be destroyed if they are used beyond the absolute maximum ratings.

6. Electrical Specifications

Typical Electrical Characteristics

At Ta = 25 °C, VCC=IOVCC= 2.6V to 3.3V, GND=0V.

Table 5

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Supply voltage (logic)	VDD-GND			2.8		V
Supply current (Logic & LCD)	ICC	VDD=2.8V	-	1	10	mA
Supply voltage of white LED backlight			24.0	25.6	26.4	V
Luminance (on the module surface)		dies = 8	-	TBD	-	cd/m ²

7. Optical Characteristics

Table 7: Optical specifications

		<u>14610 7. Option 5</u>		Specifications				
Items		Symbol	Condition			Unit		
1 1 1						Max.		
brightnes	SS	$\frac{CR}{T_R}$		200	220	-	-	
Resnonse T	Response Time			-	4	8	ms	
response 1	iiiic	T_{F}		-	12	24	ms	
	Red	X_R		0.604	0.634	0.664	-	
	Reu	Y_R		0.298	0.328	0.358	ı	
	Croon	X_{G}		0.264	0.294	0.324		
Chromotioity	Green	Y_{G}		0.547	0.577	0.607	1	
Chromaticity	Blue	X_{B}		0.107	0.137	0.167		3. T /
		Y_B		0.104 0.134 0.164 -	-	Note		
	White	X_{W}		0.272	0.302	0.332	.332 -	
		Y_{W}		0.305	0.335	0.365		
	7.7	1(3 o'clock)		-	80	-		
	Hor.	2(9 o'clock)	C	-	80	-		
Viewing angle		2(12	Center		0.0		deg.	
	Ver. o'clock	o'clock)	CR≥10	-	80	-		
		1(6 o'clock))	-	80	-		
Optima View Direction					All			

Note 1: Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression.

Contrast Ratio (CR) = L63 / L0

L63: Luminance of gray level 63

L0: Luminance of gray level 0

CR = CR (10)

CR (X) is corresponding to the Contrast Ratio of the point X at Figure in Note 5.

Note 2: Definition of Response Time (TR, TF):

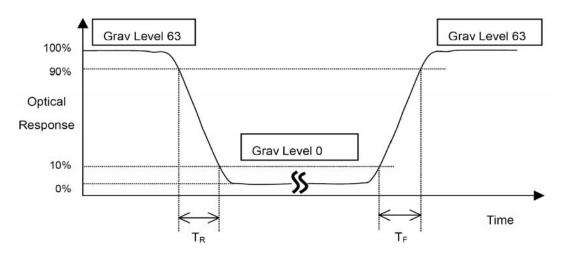
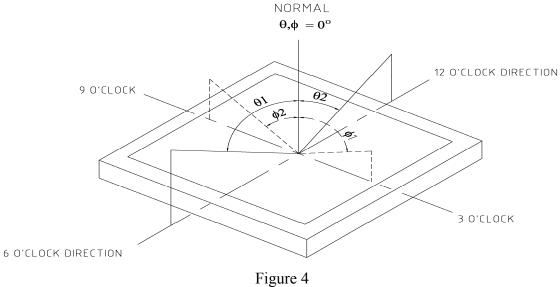


Figure 3

Note 3: Viewing Angle



The above "Viewing Angle" is the measuring position with Largest Contrast Ratio; not for good image quality. View Direction for good image quality is 6 O'clock. Module maker can increase the "Viewing Angle" by applying Wide View Film.

Note 4: Measurement Set-Up:

The LCD module should be stabilized at a given temperature for 20 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement

should be executed after lighting Backlight for 20 minutes in a windless room.

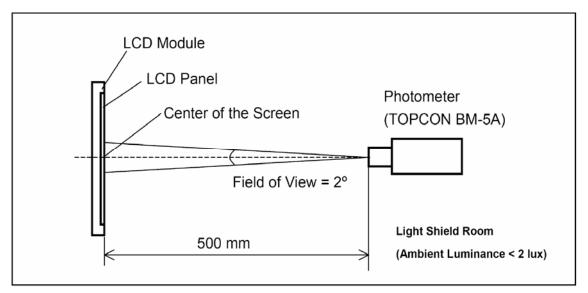
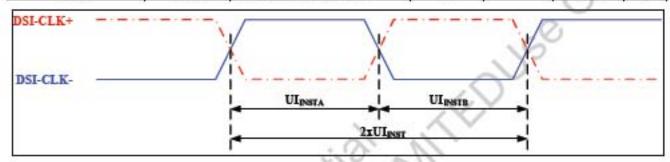


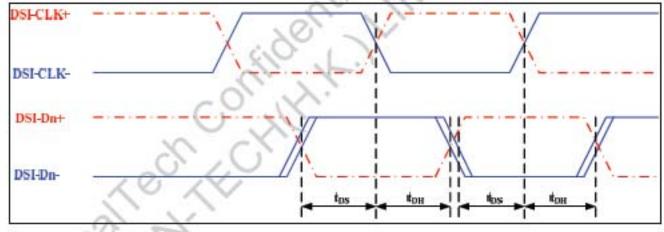
Figure 5

Timing Characteristics

8.1 MIPI-DSI High speed mode

Parameter	and the same of	Parameter	Specification			
Parameter	Symbol	Parameter	MIN	TYP	MAX	Unit
High Speed mode		ů.		2		S)
DSI-CLK+/-	2xUI _{MBT}	Double UI Instantaneous	4	9 SP 53	25	na
DSI-CLK+/-	Ulesta, Uleans	UI Instantaneous Halfs	2	3 15 3	12.5	na
DSI-Dn+/-	tos	Data to clock setup time	0.15			UI
DSI-Dn+/-	ton	Data to clock hold time	0.15	- 4	28	UI
DSI-CLK+/-	torrelk	Differential rise time for clock	150	38	0.3UI	рв
DSI-Dn+/-	t _{DRTDATA}	Differential rise time for data	150	2 3	0.3UI	рв
DSI-CLK+/-	torrelk.	Differential fall time for clock	150	*	0.3UI	рв
DSI-Dn+/-	t _{oftoata}	Differential fall time for data	150	P 9	0.3UI	рв





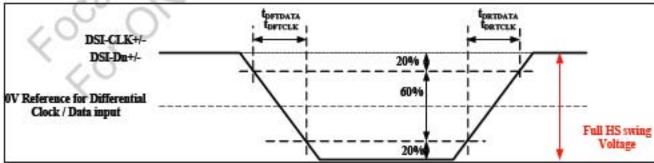


Figure 7. 80-system Bus Timing

8.2 Reset Operation of IC

Table 9: Reset Timing Characteristics (VCC = IOVCC=2.4~3.3V)

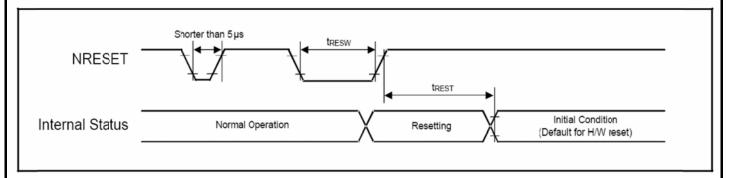


Figure 8: Reset Timing

9. Reliability Test Item

Test Item	Sample Type	Test Condition	Test result determinant gist
High temperature	Normal temperature	60±3°C;96H	the inspection of
storage	Wide temperature	70±3°C;96H	appearance and function
Low temperature	Normal temperature	-20±3℃;120H	character.
storage	Wide temperature	-30±3℃;120H	
High temperature	Normal temperature	50°C±3°C,90%±3%RH;96H	
/humidity storage	Wide temperature	60°C±3°C,90%±3%RH;96H	
High temperature	Normal temperature	60±3°C;96H	No objection of the function
operation	Wide temperature	70±3°C;96H	character; no fatal objection of
Low temperature	Normal temperature	0±3°C;96H	the appearance.
operation	Wide temperature	-20±3°C;96H	
High temperature	Normal temperature	40°C±3°C,90%±3%RH;96H	
/humidity operation	Wide temperature	50°C±3°C,90%±3%RH;96H	
Temperature Shock	Normal temperature	-20±3°C,30min→70±3°C,30 min;10cycle	inspect the objections appearance, function & the whole structure
	Wide temperature	-30±3 °C,30min 80±3,30min;10cycle	The inspection of appearance function & the whole structure

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10. Suggestions for using LCD modules

10.1 Handling of LCM

- 1. The LCD screen is made of glass. Don't give excessive external shock, or drop from a high place.
- 2. If the LCD screen is damaged and the liquid crystal leaks out, do not lick and swallow. When the liquid is attach to your hand, skin, cloth etc, wash it off by using soap and water thoroughly and immediately.
- 3. Don't apply excessive force on the surface of the LCM.
- 4. If the surface is contaminated ,clean it with soft cloth. If the LCM is severely contaminated , use Isopropyl alcohol/Ethyl alcohol to clean. Other solvents may damage the polarizer . The following solvents is especially prohibited: water , ketone Aromatic solvents etc.
- 5. Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- 6. Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- 7. Don't disassemble the LCM.
- 8. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - Be sure to ground the body when handling the LCD modules.
 - Tools required for assembling, such as soldering irons, must be properly grounded.
 - To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions.
 - The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.
- 9. Do not alter, modify or change the the shape of the tab on the metal frame.
- 10. Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.

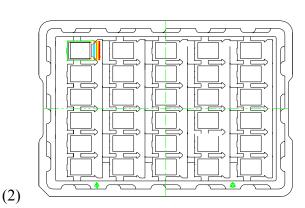
- 11. Do not damage or modify the pattern writing on the printed circuit board.
- 12. Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector
- 13. Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
- 14. Do not drop, bend or twist LCM.

10.2 Storage

- 1. Store in an ambient temperature of 5 to 45 °C, and in a relative humidity of 40% to 60%. Don't expose to sunlight or fluorescent light.
- 2. Storage in a clean environment, free from dust, active gas, and solvent.
- 3. Store in antistatic container.

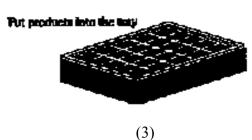
11. Packing (Reference only)

Packing Method

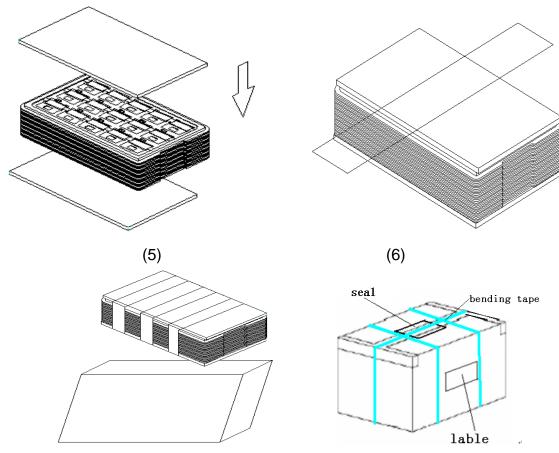




(1)



(4)



- 1. Put module into tray cavity:
- 2. Tray stacking
- 3. Put 1 cardboard under the tray stack and 1 cardboard above:
- 4. Fix the cardboard to the tray stack with adhesive tape:
- 5. Put the tray stack into carton.
- 6. Carton sealing with adhesive tape.

- END -